

## 具备3V至5.5V供电、2发/2收、250kbps、关断模式 RS-232收发器

UM3221EEAE SSOP16  
UM3221EEUE TSSOP16

### 1 描述

UM3221E是3.3V供电的RS-232收发器，适用于便携式或手持式应用。UM3221E具有一个驱动器和一个接收器。该器件具有低功耗、高数据速率能力和增强型ESD保护功能。所有发射器输出和接收器输入的ESD额定值在人体放电模式下为 $\pm 15\text{kV}$ ，在IEC61000-4-2空气间隙放电下为 $\pm 15\text{kV}$ ，在IEC61000-4-2接触放电下超过 $\pm 8\text{kV}$ 。逻辑I/O引脚的ESD额定值在人体放电模式下为 $\pm 2\text{kV}$ 。

UM3221E 具备小占板面积和扁平封装的特点，并使用  $0.1\mu\text{F}$  电容，可节省电路板空间。在最大负载条件下，数据传输率大于 250kbps。

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### 2 应用

- 工业自动化设备
- 电池供电设备
- 手持设备
- POS 终端

### 3 特性

- 通过+3.0V至+5.5V电源供电，符合真正的EIA/TIA-232-F标准
- 符合 EIA/TIA-562  $\pm 3.7\text{V}$  的电平，电源电压低至  $2.7\text{V}$
- 增强ESD规格：
  - $\pm 15\text{kV}$  人体放电模型
  - $\pm 15\text{kV}$  IEC61000-4-2 空气间隙放电
  - $\pm 8\text{kV}$  IEC61000-4-2 接触放电
- $1\mu\text{A}$  低功耗关断模式
- 250kbps 最低传输速率
- 保证 $30\text{V}/\mu\text{s}$ 最大压摆率
- 闩锁性能(Latch-Up)超过200mA

### 4 订购信息

芯片型号	工作温度范围	封装类型	发货数量
UM3221EEAE	-40 °C to +85 °C	SSOP16	2000pcs/13 Inch Tape & Reel
UM3221EEUE	-40 °C to +85 °C	TSSOP16	3000pcs/13 Inch Tape & Reel

## 5 Pin Configuration and Function

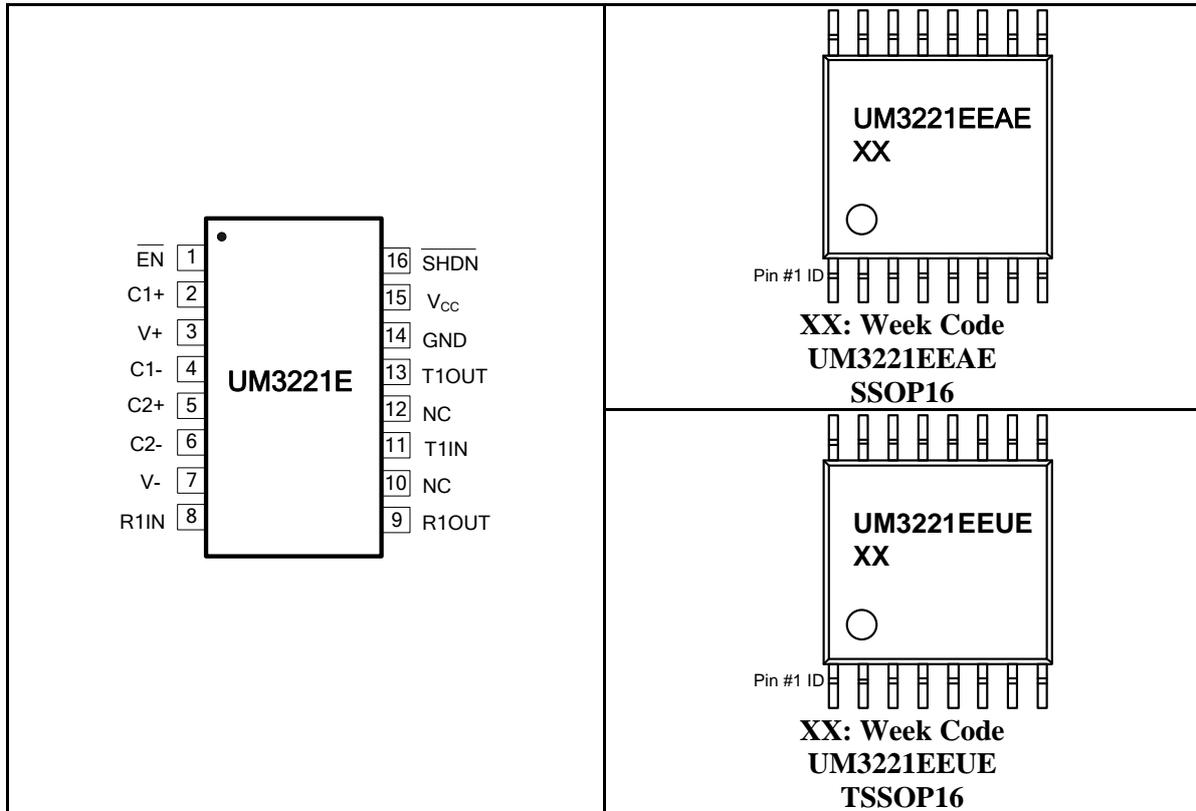


Table 5-1. Pin Functions

Pin No.	Pin Name	Function
1	$\overline{EN}$	Receiver Enable. Active low.
2	C1+	Positive Terminals of Voltage-Doubler Charge Pump Capacitor
3	V+	Positive Voltage Generated by the Charge Pump
4	C1-	Negative Terminals of Voltage-Doubler Charge Pump Capacitor
5	C2+	Positive Terminals of Inverting Charge Pump Capacitor
6	C2-	Negative Terminals of Inverting Charge Pump Capacitor
7	V-	Negative Voltage Generated by the Charge Pump
8	R1IN	RS-232 Receiver Input
9	R1OUT	RS-232 Receiver Output
10, 12	NC	Not connected
11	T1IN	RS-232 Driver Input
13	T1OUT	RS-232 Driver Output
14	GND	Ground
15	V <sub>CC</sub>	+3.0V to +5.5V Supply Voltage Input
16	$\overline{SHDN}$	Shut off Pump Power and Transmitters. Active low.

## 6 Specifications

### 6.1 Absolute Maximum Ratings (Note 1)

Symbol	Parameter		Value	Unit
V <sub>CC</sub>	Supply Voltage on V <sub>CC</sub>		-0.3 to +6	V
V <sub>+</sub>	Voltage on V <sub>+</sub>		(V <sub>CC</sub> -0.3) to +7.5	V
V <sub>-</sub>	Voltage on V <sub>-</sub>		-7.5 to +0.3	V
T1IN	Voltage on T1IN		-0.3 to (V <sub>CC</sub> +0.3)	V
R1IN	Voltage on R1IN		±30	V
T1OUT	Voltage on T1OUT		(V <sub>-</sub> -0.3) to (V <sub>+</sub> +0.3)	V
R1OUT	Voltage on R1OUT		-0.3 to (V <sub>CC</sub> +0.3)	V
	Short-Circuit Duration, T1OUT		Continuous	
P <sub>D</sub>	Continuous Power Dissipation at T <sub>A</sub> =70 °C	SSOP16	775	mW
		TSSOP16	754	
T <sub>A</sub>	Operating Temperature Range		-40 to +85	°C
T <sub>STG</sub>	Storage Temperature Range		-65 to +165	°C
T <sub>L</sub>	Lead Temperature for Soldering 10 Seconds		+260	°C

Note 1: Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**6.2 Electrical Characteristics**

$V_{CC}=+3.0V$  to  $+5.5V$ ,  $C1- C4=0.1\mu F$ ,  $T_A=T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted. Typical values are at  $T_A=25\text{ }^\circ\text{C}$ .

Parameter	Symbol	Conditions	Min	Typ	Max	Unit	
<b>DC CHARACTERISTICS (<math>V_{CC}=+3.3V</math> or <math>+5V</math>, <math>T_A=25\text{ }^\circ\text{C}</math>)</b>							
$V_{CC}$ Supply Current	$I_{CC}$	$\overline{SHDN}=V_{CC}$ , No Load			1.5	mA	
Shutdown Supply Current	$I_{SHDN}$	$\overline{SHDN}=\overline{GND}$			1	$\mu\text{A}$	
<b>LOGIC INPUTS</b>							
Input Leakage Current		$T1IN, \overline{SHDN}, \overline{EN}$			$\pm 1$	$\mu\text{A}$	
Input Threshold Low	$V_{IL}$	$T1IN, \overline{SHDN}, \overline{EN}$	$V_{CC}=3.3V$		0.8	V	
			$V_{CC}=5.0V$		0.8		
Input Threshold High	$V_{IH}$	$T1IN, \overline{SHDN}, \overline{EN}$	$V_{CC}=3.3V$	1.6		V	
			$V_{CC}=5.0V$	2.2			
Transmitter Input Hysteresis			$V_{CC}=3.3V$		0.2	V	
			$V_{CC}=5.0V$		0.15		
<b>RECEIVER OUTPUTS</b>							
Output Voltage Low	$V_{OL}$		$V_{CC}=3.3V, I_{OUT}=1.6mA$		0.8	V	
			$V_{CC}=5.0V, I_{OUT}=1.6mA$		0.8		
Output Voltage High	$V_{OH}$		$V_{CC}=3.3V, I_{OUT}=-1.0mA$	2.8		V	
			$V_{CC}=5.0V, I_{OUT}=-1.0mA$	4.4			
<b>RECEIVER INPUTS</b>							
Input Voltage Range			-30		30	V	
Input Threshold Low		$T_A=+25\text{ }^\circ\text{C}$	$V_{CC}=3.3V$	0.8	1.15	V	
			$V_{CC}=5.0V$	0.8	1.55		
Input Threshold High		$T_A=+25\text{ }^\circ\text{C}$	$V_{CC}=3.3V$		1.35	V	
			$V_{CC}=5.0V$		1.75		
Input Hysteresis				0.2		V	
Input Resistance		$T_A=+25\text{ }^\circ\text{C}$	3	5	7	k $\Omega$	
<b>TRANSMITTER OUTPUTS</b>							
Output Voltage Swing		All Drivers Loaded with 3k $\Omega$ to Ground	$\pm 5.0$	$\pm 6.0$		V	
Output Short-Circuit Current		Short to $V_{CC}$ , GND or Other TXD Pin	$V_{CC}=3.3V$		$\pm 30$	$\pm 60$	mA
			$V_{CC}=5.0V$		$\pm 40$	$\pm 60$	mA

**Electrical Characteristics (Continued)**

( $V_{CC}=+3.0V$  to  $+5.5V$ ,  $C1- C4=0.1\mu F$ ,  $T_A=T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted. Typical values are at  $T_A=25\text{ }^\circ\text{C}$ )

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
<b>TIMING CHARACTERISTICS</b>						
Maximum Data Rate		$R_L=3k\Omega$ to $7k\Omega$ , $C_L=50pF$ to $1000pF$ , One Transmitter Switching		250		kbps
Receiver Propagation Delay	$t_{PLH}$ , $t_{PHL}$	$C_L=150pF$ , see Figure 8-1		0.15		$\mu s$
Receiver Skew	$ t_{PHL}-t_{PLH} $				0.1	$\mu s$
Transmitter Propagation Delay	$t_{PLH}$ , $t_{PHL}$	$R_L=3k\Omega$ , $C_L=2500pF$ , All Transmitters Loaded, see Figure 8-1		0.9		$\mu s$
Transmitter Skew	$ t_{PHL}-t_{PLH} $				0.1	$\mu s$
Transition-Region Slew Rate		$T_A=+25\text{ }^\circ\text{C}$ , $V_{CC}=3.3V$ , $R_L=3k\Omega$ to $7k\Omega$ , $C_L=50pF$ to $1000pF$ , Measured from $-3V$ to $+3V$ or $+3V$ to $-3V$ , see Figure 8-1	3	15	30	$V/\mu s$
<b>ESD AND LATCH UP PERFORMANCE</b>						
R_IN, T_OUT ESD-Protection Voltage		Human Body Model		$\pm 15$		kV
		IEC61000-4-2, Contact Discharge		$\pm 8$		
		IEC61000-4-2, Air-Gap Discharge		$\pm 15$		
Logic Pin ESD-Protection Voltage		Human Body Model		$\pm 2$		kV
Latch Up Performance		JEDEC Standard No.78D		$\pm 200$		mA

## 7 Detailed Description

### 7.1 Dual Charge-Pump Voltage Converter

The UM3221E's internal power supply consists of a regulated dual charge pump and provides output the maxim voltages of +7V (doubling charge pump) and -7V (inverting charge pump) over the +3.0V to +5.5V  $V_{CC}$  range. The charge pump operates in discontinuous mode; if the output voltages are less than 7V, the charge pump is enabled, and if the output voltages exceed 7V, the charge pump is disabled. The charge pumps require only four small, external 0.1 $\mu$ F capacitors for the voltage doubler and inverter functions (see Figure 9-2).

### 7.2 RS-232 Transmitter

The transmitter is inverting level translator that translates TTL/CMOS inputs to EIA/TIA-232 output levels. The transmitter guarantees a 250kbps data rate for full load conditions (3k $\Omega$  and 1000pF). The transmitter can be paralleled to drive multiple receivers. When T1IN is not driven, UM3221 will keep logic high.

### 7.3 RS-232 Receiver

The receiver converts RS-232 signals to CMOS output levels and accepts inputs up to  $\pm 30$ V while presenting the required 3k $\Omega$  to 7k $\Omega$  input impedance. The UM3221E receiver has inverting three-state outputs. Drive  $\overline{EN}$  high to place the receivers into a high impedance state. Receiver can be either active or inactive in shutdown state depending on  $\overline{EN}$  status.

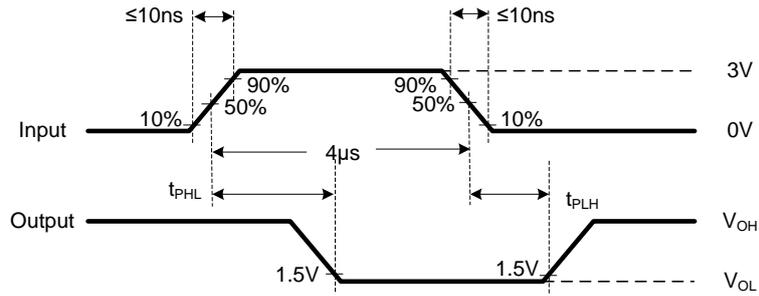
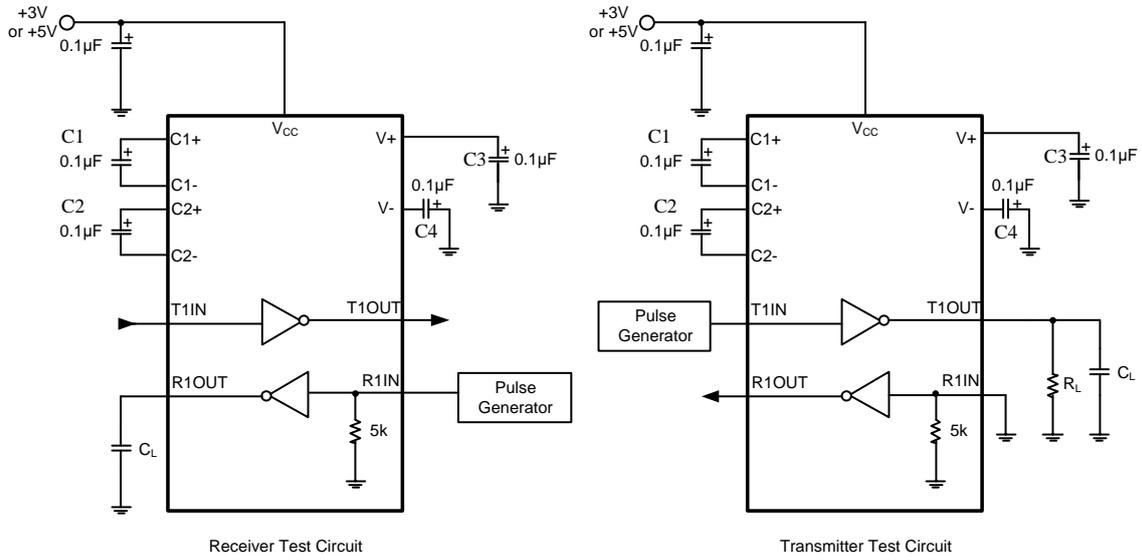
### 7.4 Shutdown Mode

Supply current falls to less than 1 $\mu$ A in shutdown mode ( $\overline{SHDN} = \text{GND}$ ). When shutdown, the device's charge pumps are shut off,  $V+$  is pulled down to  $V_{CC}$ ,  $V-$  is pulled to ground, and the transmitter outputs are disabled (high impedance). The time required to recover from shutdown is typically 100 $\mu$ s. Connect  $\overline{SHDN}$  to  $V_{CC}$  if shutdown mode is not used.  $\overline{SHDN}$  has no effect on R1OUT.

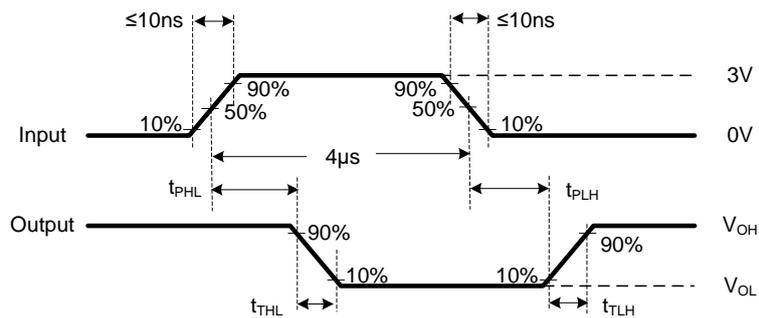
### 7.5 ESD Protection

All pins on UM3221E include ESD protection structures, but the family incorporates advanced structures which allow the RS-232 pins (transmitter outputs and receiver inputs) to survive ESD events up to  $\pm 15$ kV. The RS-232 pins are particularly vulnerable to ESD damage because they are typically connected to an exposed port on the exterior of the finished product. The ESD structures withstand high ESD in all states: normal operation, shutdown and powered down. After an ESD event, circuits keep working without latch up. ESD protection can be tested in various ways; the transmitter outputs and receiver inputs are characterized for protection to the following limits:  $\pm 15$ kV using the Human Body Model,  $\pm 8$ kV using the Contact Discharge method specified in IEC61000-4-2,  $\pm 15$ kV using the Air-Gap Discharge method specified in IEC61000-4-2. The logic pins are characterized for protection to the following limit:  $\pm 2$ kV using the Human Body Model.

## 8 Parameter Measurement Information



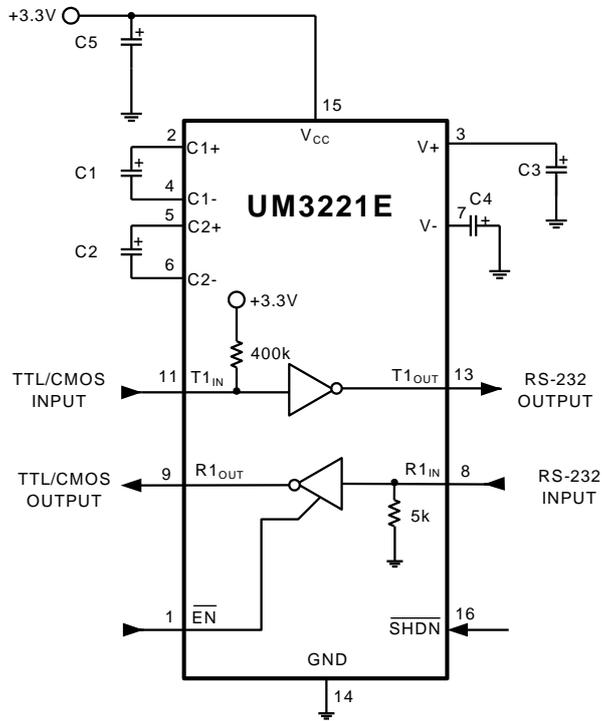
Receiver Waveforms



Transmitter Waveforms

Figure 8-1

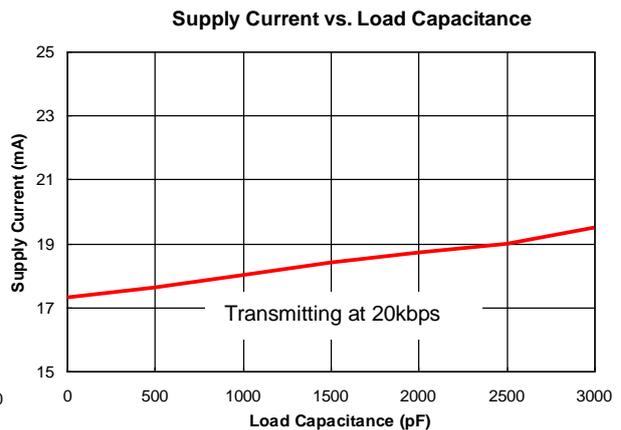
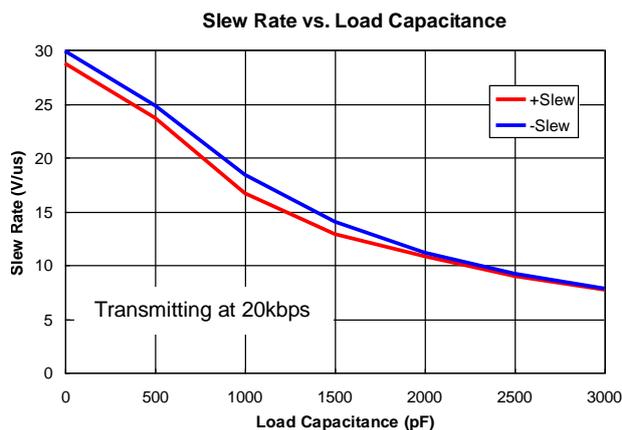
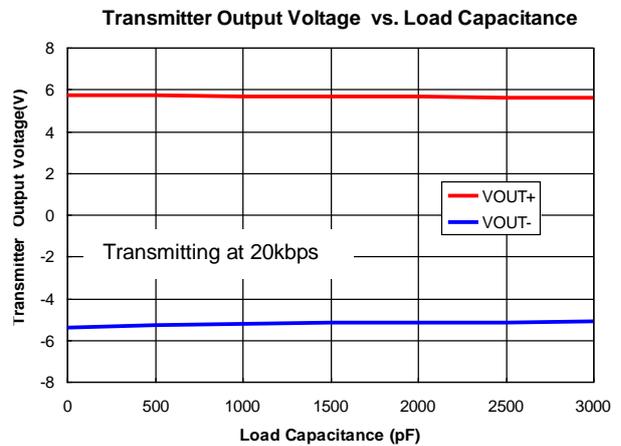
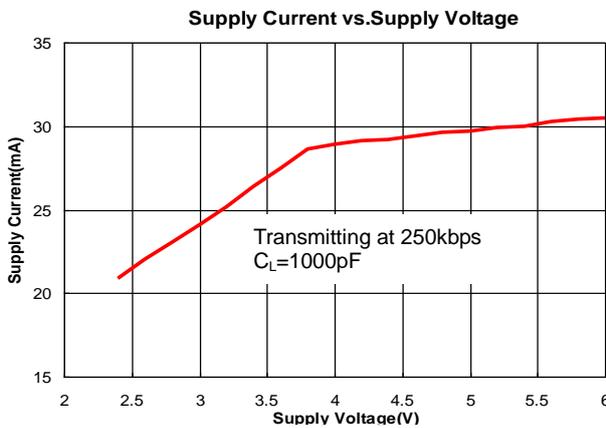
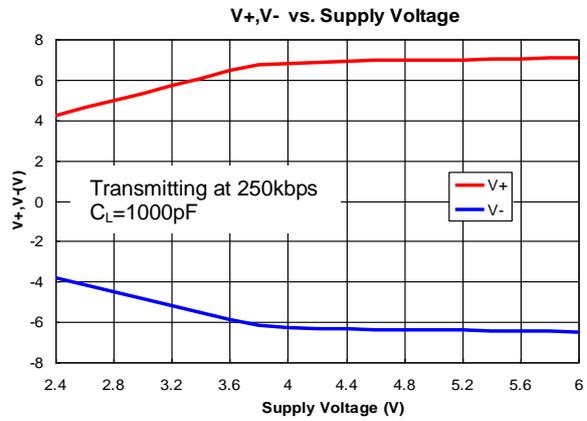
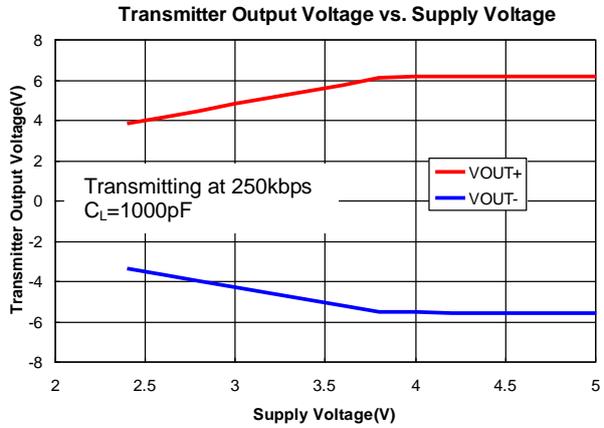
**9 Typical Operating Circuits**



**Figure 9-2**

## 10 Typical Operating Characteristics

$V_{CC}=+3.3V$ , 250kbps data rate,  $0.1\mu F$  capacitors, all transmitters loaded with  $3k\Omega$  and  $C_L$ ,  $T_A=25^\circ C$ , unless otherwise noted.



## 11 Applications Information

### 11.1 Capacitor Selection

The capacitor type used for C1–C4 is not critical for proper operation; polarized or non-polarized capacitors can be used. The charge pump requires 0.1 $\mu$ F capacitors for 3.3V operation. Increasing the capacitor values (e.g. by a factor of 2) reduces ripples on the transmitter outputs and slightly reduces power consumption. C2, C3 and C4 can be increased without changing C1's value. When using the minimum required capacitor values, make sure the capacitor value does not degrade excessively with temperature. If in doubt, use capacitors with a larger nominal value. The capacitor's equivalent series resistance (ESR), which usually rises at low temperatures, influences the amount of ripples on V+ and V- output voltages.

The following table shows some recommended minimum required pump capacitor values for different input voltage ranges.

Minimum Required Pump Capacitor Value	
Input Voltage $V_{CC}$	Charge Pump Capacitor Value for UM3221E
2.7V to 3.6V	C1–C4=0.1 $\mu$ F
3.6V to 5.5V	C1–C4=0.47 $\mu$ F
2.7V to 5.5V	C1–C4=0.47 $\mu$ F

### 11.2 Power Supply Decoupling

In most circumstances, a 0.1 $\mu$ F  $V_{CC}$  bypass capacitor is adequate. In applications sensitive to power-supply noise, use a capacitor of the same value as charge pump capacitor C1. Connect bypass capacitors to the IC as close as possible.

### 11.3 Operation down to 2.7V

Transmitter outputs meet EIA/TIA-562 levels of  $\pm 3.7V$  with supply voltages as low as 2.7V.

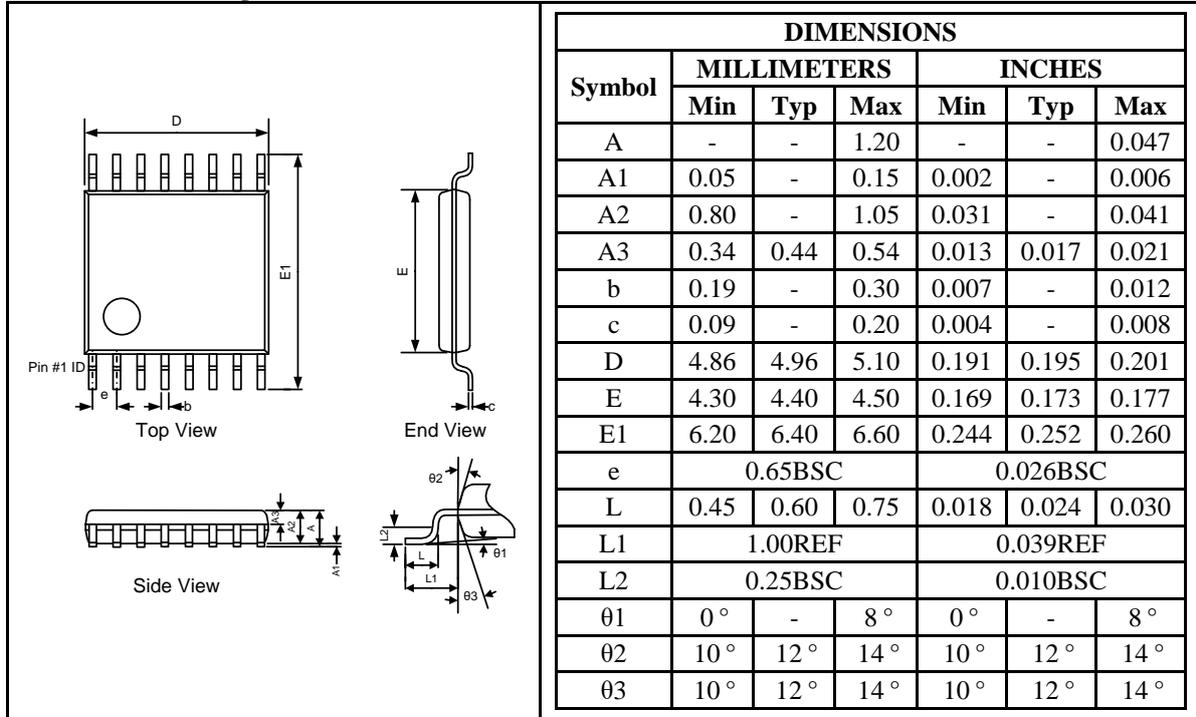
### 11.4 Interconnection with 3V and 5V Logic

The UM3221E can directly interface with various 3V and 5V logic families, including ACT and HCT CMOS.

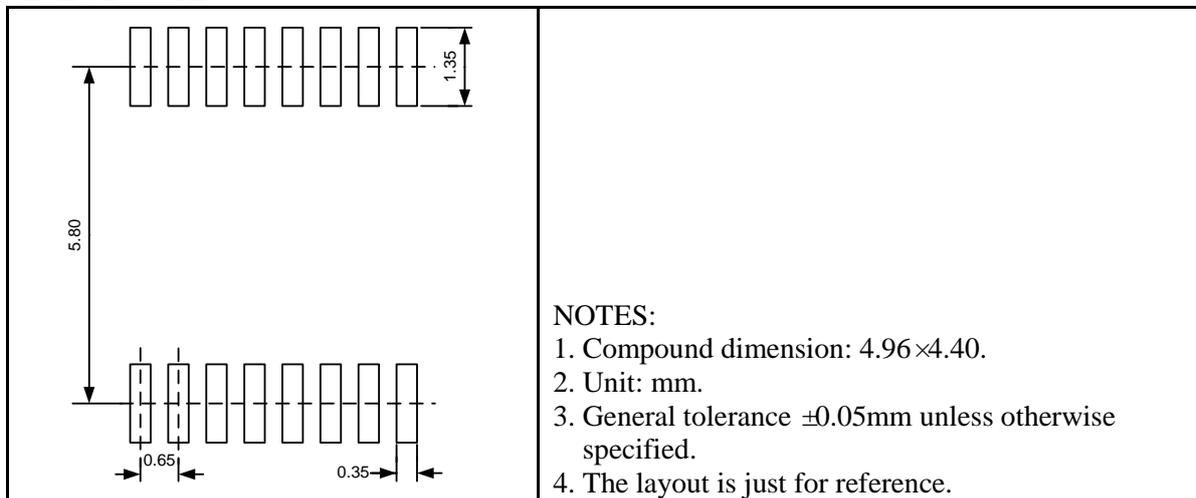
## Package Information

### TSSOP16

#### Outline Drawing

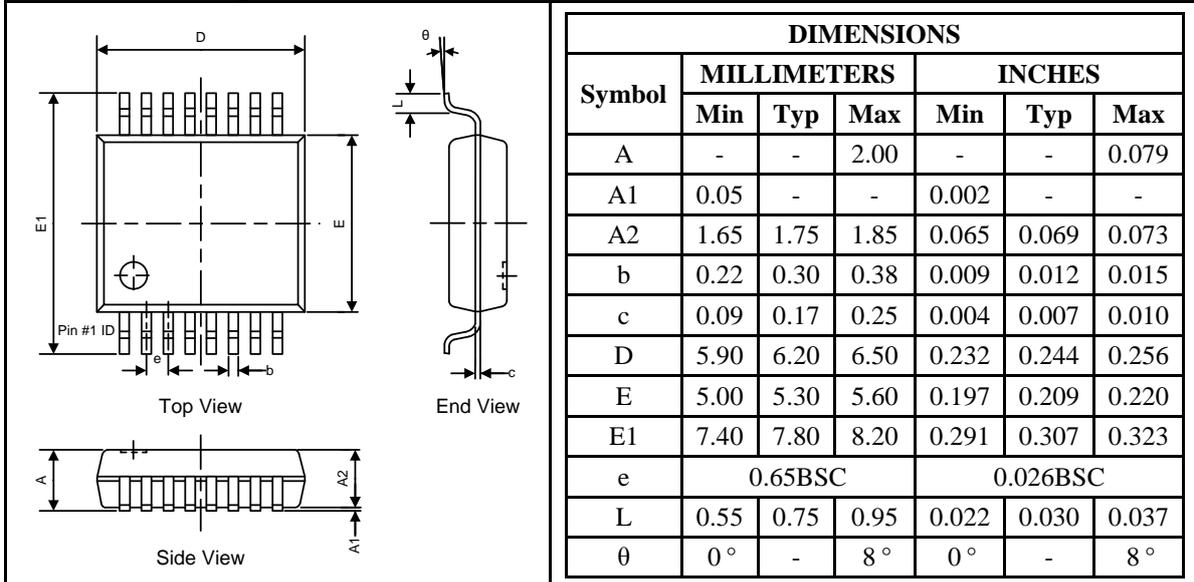


#### Land Pattern

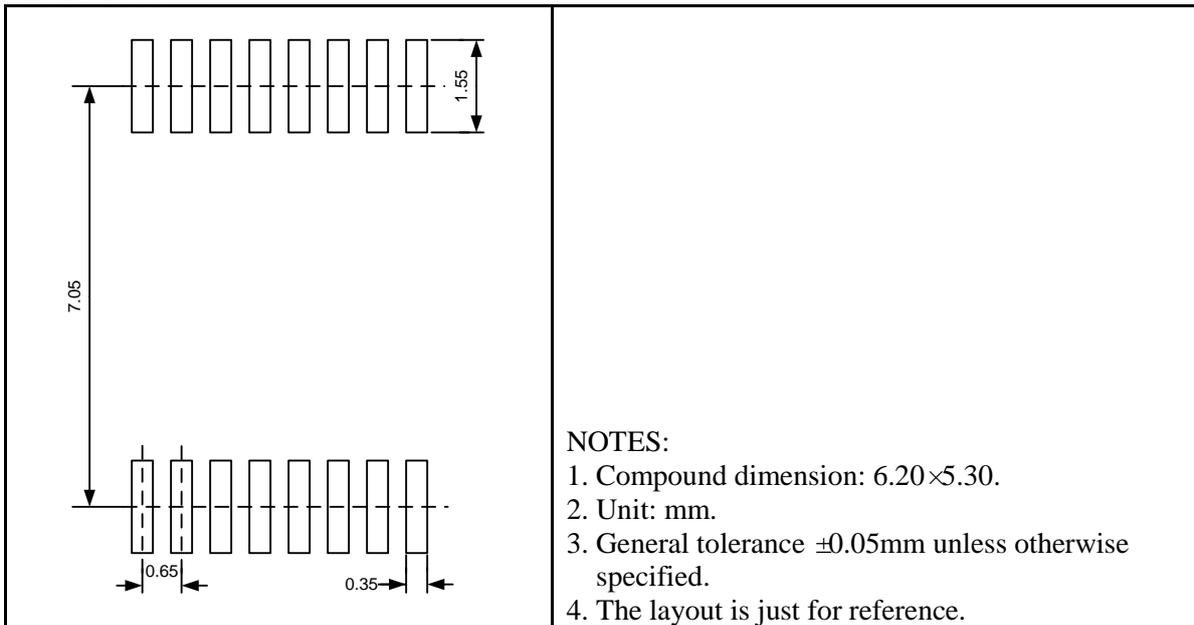


## SSOP16

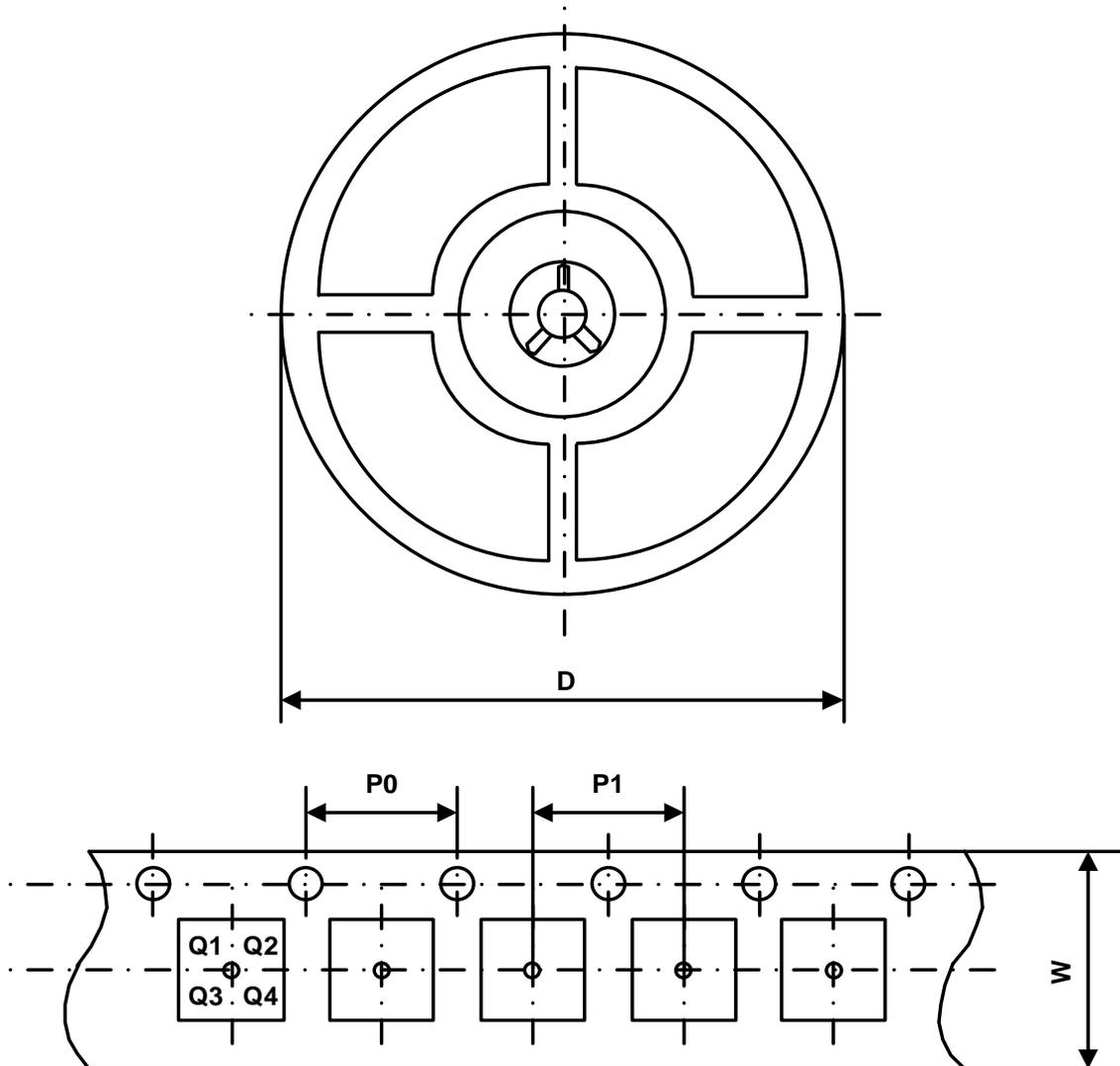
### Outline Drawing



### Land Pattern



## Packing Information



Part Number	Package Type	Carrier Width (W)	Pitch (P0)	Pitch (P1)	Reel Size (D)	PIN 1 Quadrant
UM3221EEAE	SSOP16	16 mm	4 mm	12 mm	330 mm	Q1
UM3221EEUE	TSSOP16	16 mm	4 mm	8 mm	330 mm	Q1

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